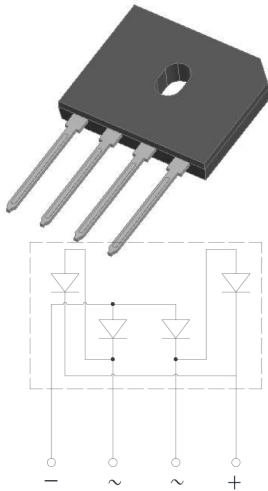


Bridge Rectifier



Features

- UL recognition, file #E230084
- Ideal for printed circuit boards
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

Mechanical Data

- **Package:** GBU
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** As marked on body

■ Maximum Ratings ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	GBU8005	GBU801	GBU802	GBU804	GBU806	GBU808	GBU810
Device marking code			GBU8005	GBU801	GBU802	GBU804	GBU806	GBU808	GBU810
Repetitive peak reverse voltage	VRRM	V	50	100	200	400	600	800	1000
Average rectified output current @60Hz sine wave, R-load	With heatsink $T_c=110^{\circ}\text{C}$	IO	A	8.0					
	Without heatsink $T_a=25^{\circ}\text{C}$			3.2					
Surge(non-repetitive)forward current @60Hz half sine wave, 1 cycle, $T_j=25^{\circ}\text{C}$	IFSM	A	175						
Current squared time @1ms≤t≤8.3ms $T_j=25^{\circ}\text{C}$, Rating of per diode	i^2t	A ² S	127						
Storage temperature	Tstg	°C	-55 ~+150						
Junction temperature	Tj	°C	-55 ~+150						
Dielectric strength @ terminals to case, AC 1 minute	Vdis	KV	2.5						
Mounting torque @recommend torque: 5kg·cm	Tor	kg·cm	8						

■ Electrical Characteristics ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GBU8005	GBU801	GBU802	GBU804	GBU806	GBU808	GBU810
Maximum instantaneous forward voltage drop per diode	V _F	V	IFM=4.0A	1.00						
Maximum DC reverse current at rated DC blocking voltage per diode	I _{RRM}	μA	V _{RM} =V _{RRM}	5						

■ Thermal Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	GBU8005	GBU801	GBU802	GBU804	GBU806	GBU808	GBU810
Thermal Resistance	Between junction and ambient, Without heatsink	R θ J-A	°C/W	25.0						
	Between junction and case, With heatsink	R θ J-C		2.3						

■ Characteristics (Typical)

FIG1:Io-Tc Curve

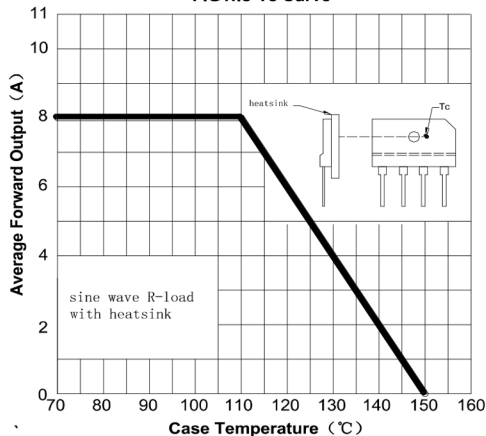


FIG2:Surge Forward Current Capability

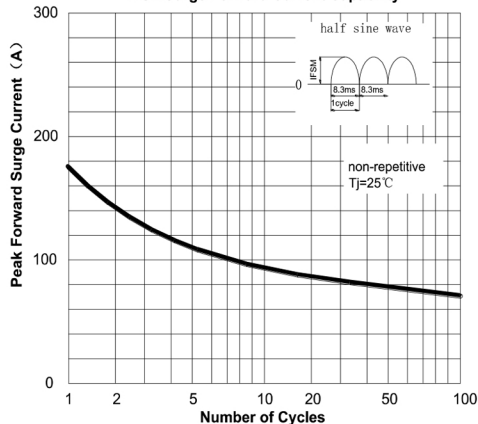


FIG3: Forward Voltage

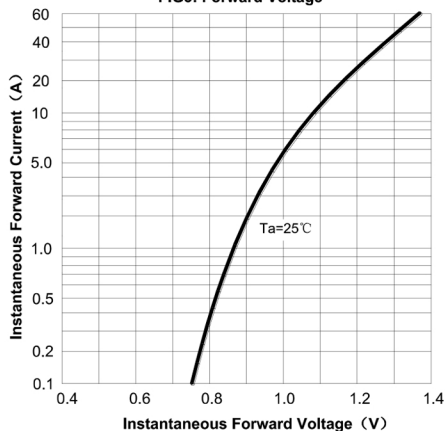
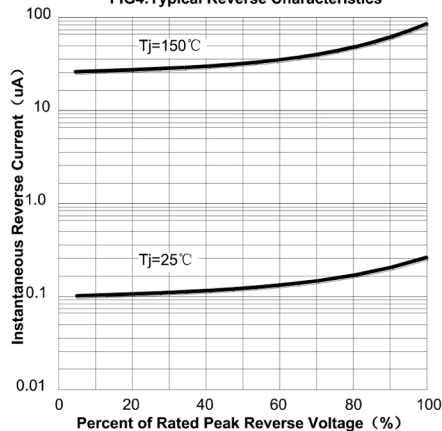
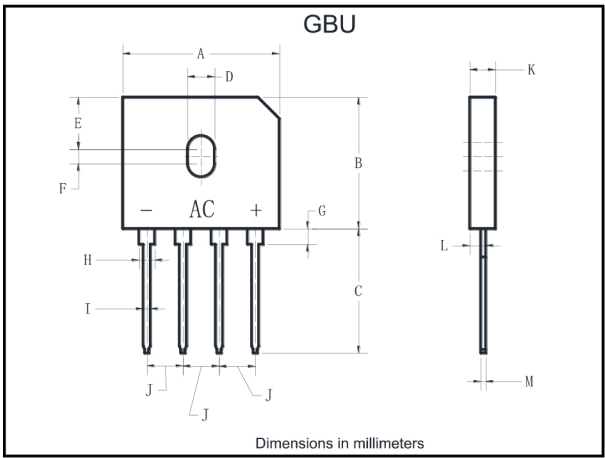


FIG4:Typical Reverse Characteristics



■ Outline Dimensions



GBU		
Dim	Min	Max
A	21.80	22.30
B	18.30	18.80
C	17.50	18.00
D	3.50	4.10
E	7.40	7.90
F	1.65	2.16
G	1.91	2.54
H	2.06	2.54
I	1.02	1.27
J	4.83	5.33
K	3.30	3.56
L	2.40	2.66
M	0.46	0.56

单击下面可查看定价，库存，交付和生命周期等信息

[>>RCD\(达标电子\)](#)